

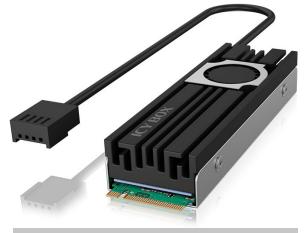
ICY BOX IB-M2HSF-703

Heat sink with fan for M.2 SSD

Key features

- M.2 SSD heat sink
- Silent 20 mm fan
- Temperature reduction of up to 25%*
- Made of high-grade aluminium
- For M.2 SSD size 22x 80 mm

*Depends on SSD manufacturer, model, version and workload of the SSD



Packing content 1 x IB-M2HSF-703, 1 x counter plate, 2 x thermal pad, 1 x screwdriver, 1 x set of screws, 1 x quick installation guide

Stay cool

The IB-M2HSF-703 is a high-performance M.2 heat sink with integrated fan. Thanks to the heat sink, the temperature of your M.2 NVMe SSD can be reduced by up to 25%, ensuring long term and stable performance in your workflow. The fan ensures that the heat is dissipated efficiently.

Technical data Model Article no. EAN code Brand Colour Material M.2 card size Cooling Thermal pad

IB-M2HSF-703 60740 4250078170709 ICY BOX Black Aluminium 22x 80 mm Heat sink with 20 mm fan Material: silicone Thermal conductivity: 1.5 W/mK Operating temperature: -20° C ~ 180° C

Number of cooling fins Fan dimension Fan speed Fan rated current Fan power supply Operating system System requirements

8

o 20 x 20 x 6 mm 10.000 rpm (No speed adjustment possible) 40 mA (max. 60 mA) 4-PIN DC 12V Independent An M.2 SSD with a maximum length of 80 mm; Mounting height 16 mm

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ICY BOX **IB-M2HSF-703** Heat sink with fan for M.2 SSD



Thanks to the cooling fin

With its 8 cooling fins, which increase the surface area of the heat sink, the IB-M2HSF-703 can optimally dissipate the heat of the M.2 SSD to the environment.



Clever combination

Maximise the performance of your M.2 SSD without fear of overload. Thanks to the combination of a solid aluminium heat sink and a 20 mm fan, the IB-M2HSF-703 can achieve a reduction of the M.2 SSD temperature by up to 25%.



Logistical data	
Packing unit:	60 pcs./carton
Total weight:	8.2 kg
Gross weight: (with packing):	0.123 kg
Net weight:	0.051 kg

Thermal pad

A thermal pad serves - similar to thermal paste - to better dissipate the heat lost by electronic components and thus makes a significant contribution to heat dissipation.

Dimension/Carton: Dimension (with packing): Dimension of article: Country of Origin:

440x295x335 mm 105x200x27 mm 75x24x13 mm China

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